



A Product Line of Diodes Incorporated



FMMT722

70V PNP SILICON LOW SATURATION TRANSISTOR IN SOT23

#### **Features**

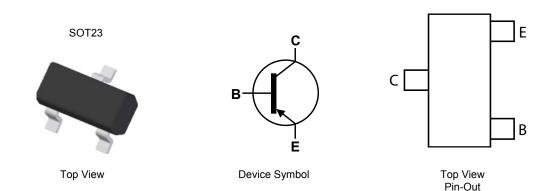
- BV<sub>CEO</sub> > -70V
- I<sub>C</sub> = -1.5A Continuous Collector Current
- I<sub>CM</sub> = -3A Peak Pulse Current
- Low Saturation Voltage V<sub>CE(sat)</sub> < -220mV @ -1A</li>
- R<sub>CE(SAT)</sub> = 140mΩ for a low equivalent on-resistance
- 625mW power dissipation
- h<sub>FE</sub> characterised up to -3A for high current gain hold-up
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

### **Mechanical Data**

- Case: SOT23
- Case Material: molded plastic, "Green" molding compound
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 <sup>(23)</sup>
- Weight 0.008 grams (approximate)

#### Applications

- High-side driver
- Load disconnect switch
- Motor drive



### Ordering Information (Note 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FMMT722TA	AEC-Q101	722	7	8	3,000
FMMT722QTA	Automotive	722	7	8	3,000

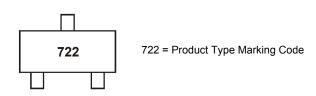
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>

 Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.

5. For packaging details, go to our website at http://www.diodes.com

### **Marking Information**







### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-70	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-70	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	Ι <sub>C</sub>	-1.5	A
Peak Pulse Current	I <sub>CM</sub>	-3	A
Base Current	IB	-500	mA

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	625	mW
Power Dissipation (Note 7)	PD	806	mW
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	200	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	R <sub>0JA</sub>	155	°C/W
Thermal Resistance, Junction to Leads (Note 8)	R <sub>0JL</sub>	194	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С

Notes: 6. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

7. Same as note 6, except the device is measured at t ≤ 5 sec.

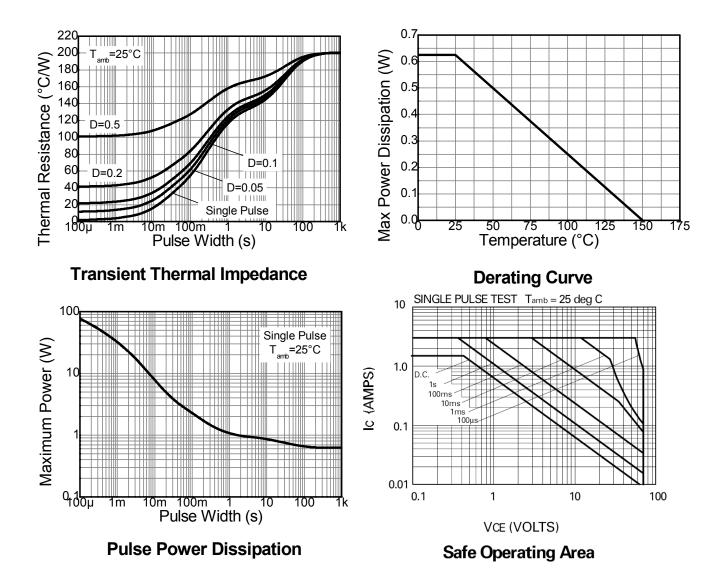
8. Thermal resistance from junction to solder-point (at the end of the collector lead).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.





# Thermal Characteristics and Derating information







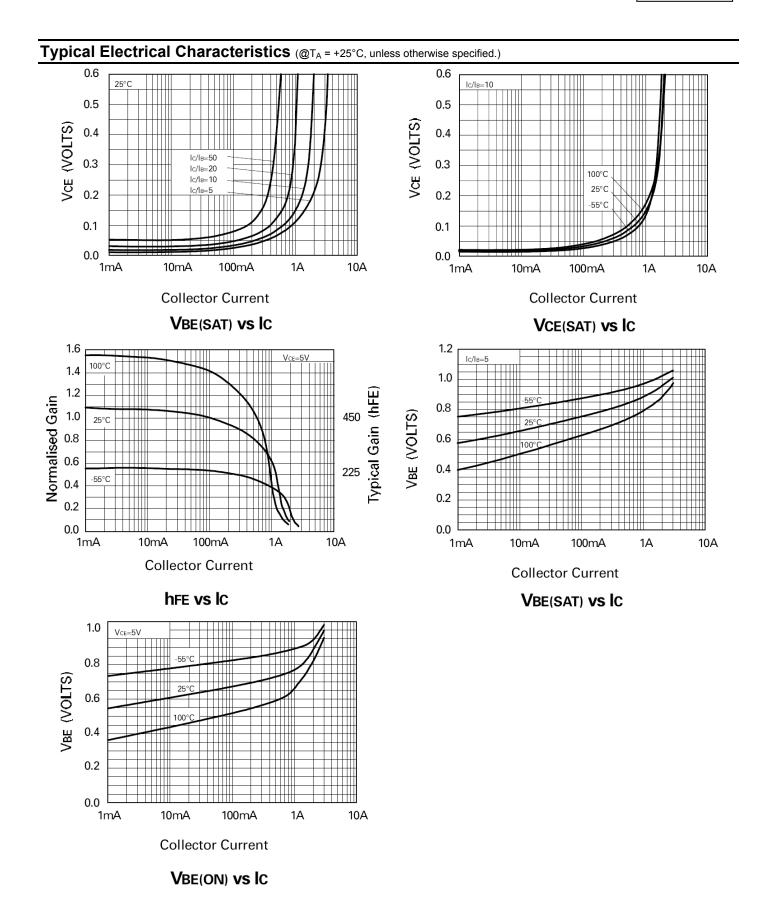
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-70	-150	-	V	$I_{\rm C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 10)	BVCEO	-70	-125	-	V	$I_{\rm C} = -10 \mathrm{mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.8	-	V	I <sub>E</sub> = -100μA
Collector Cutoff Current	I <sub>CBO</sub>	-	<1	-100	nA	$V_{CB} = -60V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	<1	-100	nA	V <sub>EB</sub> = -5.6V
Collector Emitter Cutoff Current	I <sub>CES</sub>	-	<1	-100	nA	V <sub>CE</sub> = -60V
	h <sub>FE</sub>	300	470	-	-	I <sub>C</sub> = -10mA, V <sub>CE</sub> = -5V
		300	450	-		I <sub>C</sub> = -0.1A, V <sub>CE</sub> = -5V
Static Forward Current Transfer Ratio (Note 10)		175	275	-		I <sub>C</sub> = -1A, V <sub>CE</sub> = -5V
		40	60	-		I <sub>C</sub> = -1.5A, V <sub>CE</sub> = -5V
		-	10	-		I <sub>C</sub> = -3A, V <sub>CE</sub> = -5V
	V <sub>CE(sat)</sub>	-	-35	-50	mV	I <sub>C</sub> =- 0.1A, I <sub>B</sub> = -10mA
Collector Emitter Seturation Voltage (Note 10)		-	-135	-200		I <sub>C</sub> = -0.5A, I <sub>B</sub> = -20mA
Collector-Emitter Saturation Voltage (Note 10)		-	-140	-220		I <sub>C</sub> = -1A, I <sub>B</sub> = -100mA
		-	-175	-260		I <sub>C</sub> = -1.5A, I <sub>B</sub> = -200mA
Base-Emitter Turn-On Voltage(Note 10)	V <sub>BE(on)</sub>	-	-0.78	-1.0	V	I <sub>C</sub> = -1.5A, V <sub>CE</sub> = -5V
Base-Emitter Saturation Voltage(Note 10)	V <sub>BE(sat)</sub>	-	-0.94	-1.05	V	I <sub>C</sub> = -1.5A, I <sub>B</sub> = -200mA
Output Capacitance	C <sub>obo</sub>	-	14	20	pF	V <sub>CB</sub> = -10V, f = 1MHz
Transition Frequency	f <sub>T</sub>	150	200	-	MHz	V <sub>CE</sub> = -10V, I <sub>C</sub> = -50mA, f = 100MHz
Turn-On Time	t <sub>on</sub>	-	40	-	ns	$V_{CC} = -50V, I_{C} = -0.5A$
Turn-Off Time	t <sub>off</sub>	-	700	-	ns	$I_{B1} = I_{B2} = -50 \text{mA}$

10. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2% Notes:





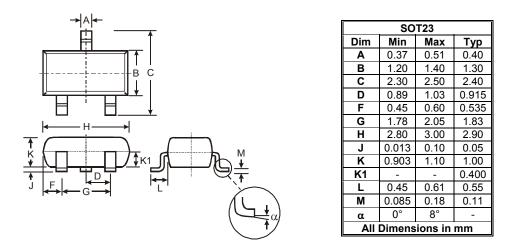






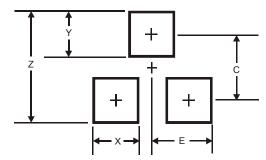
## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
F	1.35





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